Product Specification Sheet

TISG4325S-CD20TC RoHS Compliant GPON SFP OLT C+ Optical Transceiver



PRODUCT FEATURES

- Single Fiber Transceiver with single mode SC receptacle
- 1490nm continuous-mode transmitter with DFB laser
- 1310nm burst-mode receiver with APD-TIA
- Single 3.3V power supply
- Reset burst-mode receiver design
- Burst mode signal detect output which is LVTTL compatible.
- Burst mode received signal strength indication (RSSI) output
- 20Km Reach 28dB link budget
- Complies with ITU-T G984.2 Class C+
- Digital diagnostic interface compliant with SFF-8472 Rev 9.4 ,
- Complies with RoHS directive (2002/95/EC)
- Operating case temperature: Standard : 0 to +70°C

APPLICATIONS

Gigabit Passive Optical Networks (G-PON) - OLT side

PRODUCT DESCRIPTIONS

The TISG4325S-CD20TC transceiver is the high performance module for single fiber by using 1490nm continuous-mode transmitter and 1310nm burst-mode receiver. It is optical line terminal(OLT) for ITU-T G984.2. The optical transceiver is compliant with the Small Form- Factor Pluggable (SFP) Multi-Source Agreement (MSA).

The transmitter section uses a 1490nm DFB LD with automatic power control (APC) function and temperature compensation circuitry to ensure stable extinction ratio over all operating temperature range. and is Class I laser compliant IEC825 and CDRH standards. The receiver has a hermetically packaged burst-mode APD-TIA (trans-impedance amplifier) pre-amplifier and a burst-mode limiting amplifier with LVPECL compatible differential outputs.

The receiver also includes the function of burst mode signal detect output and fast RSSI output which is enabled by a trigger. When the burst optical power is on, the receiver outputs high level; when the burst optical power is off, the receiver outputs low level. Fast RSSI function can satisfy more severe timing demand to monitor the power from any ONU.

Parameter	Symbol	Min.	Max.	Unit	Note
Storage Temperature	Tst	-40	+85	°C	
Operating Case Temperature	Тс	0	70	°C	
Relative Humidity	RH	5	90	%	
Input Voltage	-	GND	Vcc	V	
Power Supply Voltage	Vcc-Vee	0	3.6	V	

ABSOLUTE MAXIMUM RATINGS

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур	Max.	Unit	Note
Supply Voltage	Vcc	3.13	3.3	3.47	V	
Supply Current	lcc			500	mA	
Operating Case Temp.	Тс	0		70	°C	

ELECTRICAL INPUT/OUTPUT CHARACTERISTICS

• Transmitter

Parame	ter	Symbol	Min.	Тур	Max.	Unit	Note
Data input Swing	Differential	V _{IN}	200		2400	mV	1
Tx Disable	Disable		2.0		Vcc	V	
I X DISADLE	Enable		0		0.8	v	
Tx Fault	Fault		2.0		Vcc	V	
IX Fault	Normal		0		0.8	V	
Input Diff. Imp	pedance	Z _{IN}	90	100	110	Ω	

Receiver

Paramete	r	Symbol	Min.	Тур	Max.	Unit	Note
By LOS Output	Н	VOH	VccR-1.05		VccR-0.85	V	2
Rx LOS Output	L	VOL	VccR-1.84		VccR-1.60	V	2
BRST Det	Н	V_DETH	2.4		Vcc		
DHO1_Det	L	V_DETL	0		0.4		

Note 1) PECL input, internally AC-coupled and terminated Note 2) Internally DC-coupled.

OPTICAL CHARACTERISTICS

Transmitter

Parameter	Symbol	Min.	Тур	Max.	Unit	Note
Operating Wavelength		1480		1500	nm	
Ave. output power (Enabled)	Po	+3		+7	dBm	1
Data Rate			2.5		Gb/s	
Average Launch Power-OFF Transmitter	Poff			-40	dBm	
Rise/Fall time (20%~80%)	Tr/Tf			160	ps	
Side Mode Suppression Ratio	SMSR	30			dB	
Extinction Ratio	ER	10			dB	
Spectral Width	Δλ		0.4	1	nm	
Output Optical Eye			Compliant v	with G984.2		

Receiver

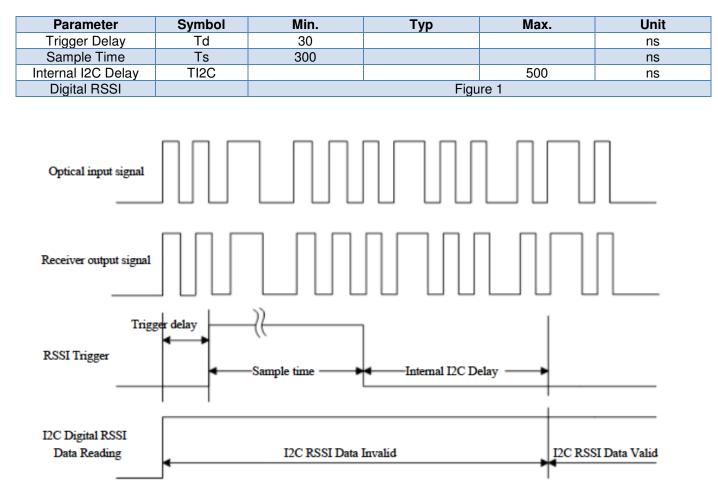
Parameter	Symbol	Min.	Тур	Max.	Unit	Note
Data Rate			1.25		Gb/s	
Operating Wavelength	λς	1260		1360	nm	
Sensitivity	Psen			-32	dBm	2
Receiver Overload	Sat	-8			dBm	2
Receiver CID Tolerance		72			Bit	
Receiver Reflectance				-20	dB	
Burst Detect De-assert	BSD_D	-45			dBm	
Burst Detect Assert	BSD_A			-34	dBm	
Burst Detect Hysteresis		1		6	dBm	
Receiver Power DDM (RSSI) Error	RXDDM			+/-3	dBm	3

Note 1) The optical power is launched into SMF. Note 2) Measured with a PRBS 2^{2^3} -1 test pattern @1250Mbps, BER $\leq 1 \times 10^{-10}$. Note 3) RSSI DDM working range is between -8 to -28 dBm. RSSI DDM accuracy is better than +/- 3dB for input power levels between -12 to -28 dBm, the accuracy reduces to +/- 5 dBm for other input power levels.

DIAGNOSTIC SPECIFICATION

Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	٦°	±3°C	Internal / External
Voltage	3.0 to 3.6	V	±3%	Internal / External
Bias Current	0 to 100	mA	±10%	Internal / External
Tx Power	1 to 8	dBm	±3dB	Internal / External
RX Power	-34 to -9	dBm	±3dB	Internal / External

TIMING CHARACTERISTICS FOR DIGITAL RSSI





TIMING CHARACTERISTICS FOR RESET

Parameter	Symbol	Min.	Тур	Max	Unit
RESET Input Signal	Reset		LVTTL		

(RESET+)					
RESET Signal Width	Tr		24		Bits
Guard Timing	Tg	32			Bits
Preamble Timing	Тр	44			Bits
Reset Delay	∆t			Tg - Tr	Bits
Burst Signal Detect On	T_BSD_On			20	ns
Burst Signal Detect Off	T_BSD_Off			20	ns
IRESET Timing		Figure 2			

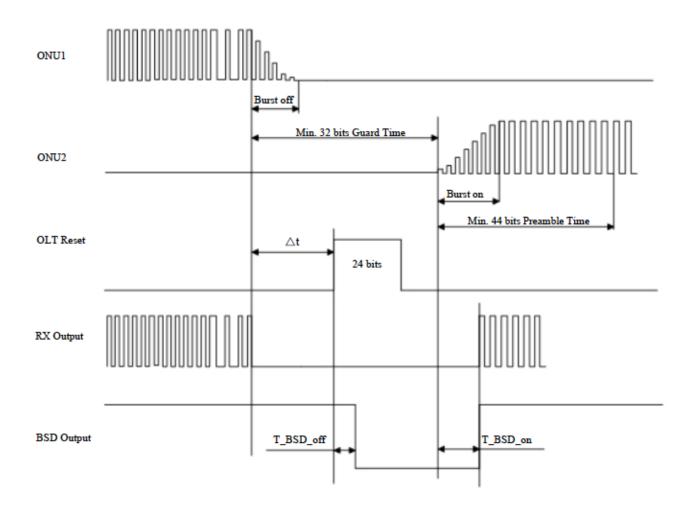


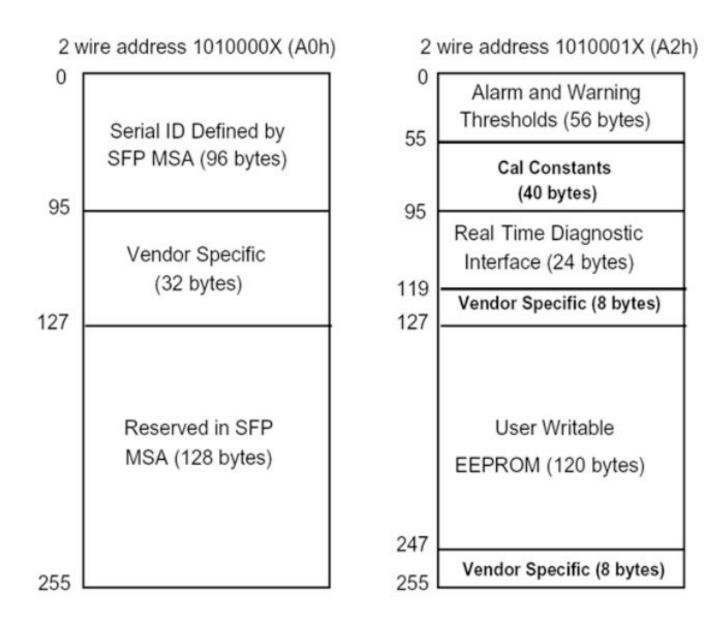
Figure 2 Reset Timing

DIGITAL DIAGNOSTIC MEMORY MAP

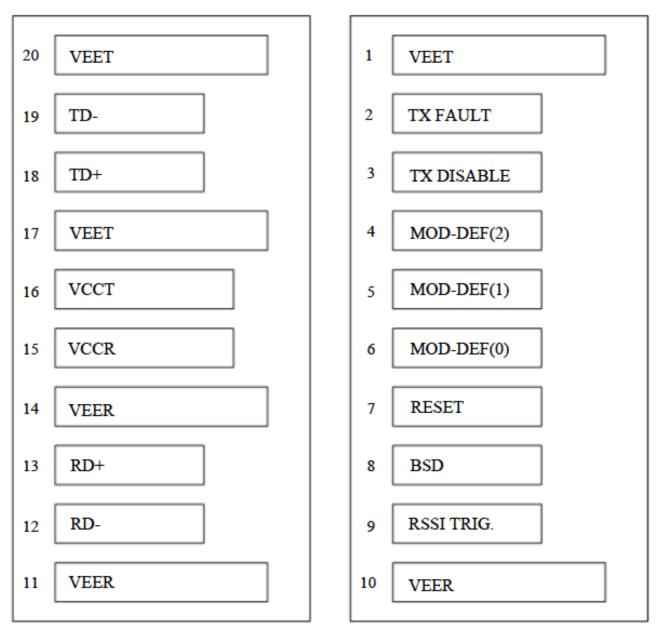
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

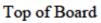
The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



PIN DIAGRAM





Bottom of Board

PIN DESCRIPTIONS

PIN #	Name	Function	Plug Seq.	Notes
1	V _{EET}	Module transmitter ground	1	
2	Tx Fault	Module Fault Indication	3	1
3	Tx Disable	Transmitter Disable;	3	2
4	MOD_DEF(2)	SDA Serial Data Signal	3	3
5	MOD_DEF(1)	SDA Serial Clock Signal	3	3
6	MOD_DEF(0)	TTL Low	3	3
7	RESET	LVTTL input. Assert "Reset" high at the end of previous burst, 16 bits in duration	3	4
8	BSD	Burst signal detect	3	5
9	RSSI TRIG	CMOS input. Assert high at the beginning of the monitored burst package at least 300ns in duration	3	6
10	V _{EER}	Module receiver ground	1	
11	V _{EER}	Module receiver ground	1	
12	RD-	Receiver inverted data out put	3	7
13	RD+	Receiver non-inverted data out put	3	7
14	V _{EER}	Module receiver ground	1	
15	V _{CCR}	Module Receiver Power Supply	2	
16	V _{CCT}	Module Transmitter Power Supply	2	
17	V _{EET}	Module transmitter ground	1	
18	TD+	Transmitter Data In	3	8
19	TD-	Transmitter Inverted Data In	3	8
20	V _{EET}	Module transmitter ground	1	

Plug Seq.: Pin engagement sequence during hot plugging.

1) TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.

2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7k \sim 10k\Omega$ resistor. Its states are:

Low (0 to 0.8V):	Transmitter on
(>0.8V, < 2.0V):	Undefined
High (2.0 to 3.465V):	Transmitter Disabled
Open:	Transmitter Disabled

3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.

Mod-Def 0 is grounded by the module to indicate that the module is present Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

4) RESET is a LVTTL input. When the previous burst signal package is end, the host will give a "high" RESET to restore the state of LA. Internal pull-down 10K resistor to GND.

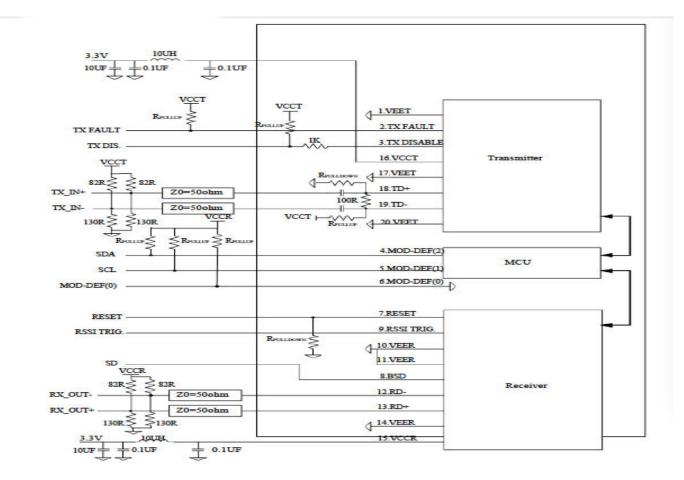
5) BSD can track the state of receiving burst signal. Logic 0 indicates loss of signal; Logic1 indicates receiving signal packages.

6) RSSI TRIG is a CMOS input. Assert high after 30ns delay time of the beginning of the monitored burst package at least 300ns in duration.

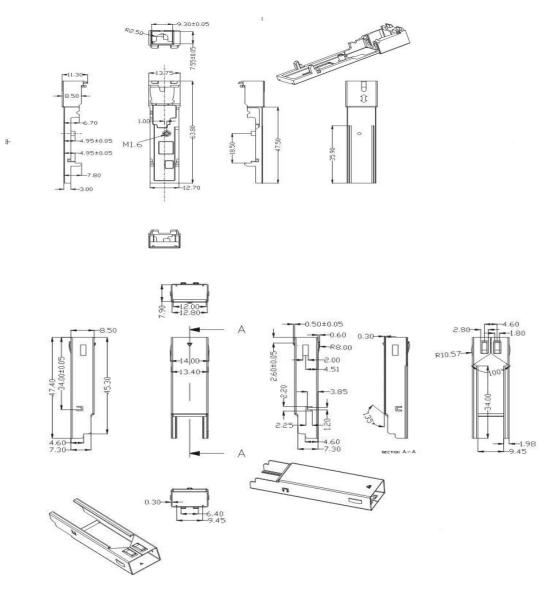
7) RD-/+: These are the differential receiver outputs. They are internally DC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.

8) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

RECOMMENDED INTERFACE CIRCUIT



PACKAGE DIMENSIONS



ORDERING INFORMATION

Part Number	Description
TISG4325S-CD20TC	Tx1490nm/ Rx1310nm , 2.5Gbps/ 1.25Gbps, Class C+, 0°C ~ +70°C With DDM; OLT Type
TISG4325S-CD20TB	Tx1490nm/ Rx1310nm , 2.5Gbps/ 1.25Gbps, Class B+, 0°C ~ +70°C With DDM; OLT Type